



MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 PUSH ROD: HI-TEMP. PLASTIC (UL 94V-0)
 LEVER: SUS
 SPRING: SUS
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -40°C~+85°C

INFORMATION

COMPATIBLE SIM TRAY DRAWING NO: ZMMCPL-002

PART NUMBER:

MMCPL - 0 8 * T - 1 2 2

SERIES ———
 NO. OF POS. ———
 CONTACT PLATED OPTION ———

T ——— TAPE REEL PACKAGE
 1 ——— TIN PLATING ON SOLDER TAIL

CONTACT PLATED OPTION

- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 6: 10u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD



TOLERANCES	
X.±0.40	.XX±0.20
.X±0.30	.XXX±0.10

REV.	A

DRAWN BY	Zhong 2019/12/24
APPROVED BY	Lion 2019/12/24

TITLE	SIM CARD, 8PIN, PCB MOUNT, SMT, ALL PLASTIC, WITH PUSH BUTTON, H=3.00mm				
DRAW NO.	MMCPL-002	UNIT	MM	Sheet	1/1